

## 4-Line Low Capacitance TVS Diode Array

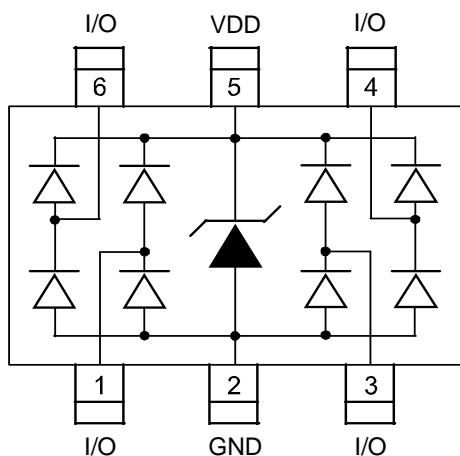
### Description

The PESDR0554S2-24A is a low capacitance TVS array, to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive high-speed data lines. The PESDR0554S2-24A has an ultra-low capacitance with a typical value at 1.5pF, and complies with the IEC 61000-4-2 (ESD) standard with  $\pm 30\text{kV}$  air and  $\pm 30\text{kV}$  contact discharge. It is assembled into a 6-Pin lead-free SOT-23-6 package. The low capacitance array make it ideal for four high speed data and transmission line. This device is optimized for ESD protection of portable electronics.

### Features

- Low capacitance: 1.5pF typical (I/O to I/O)
- Ultra low leakage: nA level
- Low operating voltage: 5V
- Low clamping voltage
- Up to 4 lines and one power line protects
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
    - Air discharge:  $\pm 30\text{kV}$
    - Contact discharge:  $\pm 30\text{kV}$
  - IEC61000-4-4 (EFT) 40A (5/50ns)
  - IEC61000-4-5 (Lightning) 24A (8/20 $\mu\text{s}$ )
- RoHS Compliant

### Dimensions and Pin Configuration



Circuit and Pin Schematic

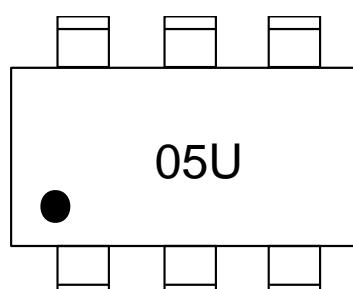
### Mechanical Characteristics

- Package: SOT-23-6
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 3 per J-STD-020
- Marking Information: See Below

### Applications

- Video/Graphics Card
- Handheld & Portable Electronics
- PC/Notebook USB2.0/IEEE1394 ports
- 10/100/1000 Ethernet
- DVI interfaces
- Wireless data (WAN/LAN) systems

### Marking Information



**05U** = Device Marking Code  
Dot denotes Pin1

### Ordering Information

Part Number	Shipping	Reel Size
PESDR0554S2-24A	3000/Tape & Reel	7 inch

**Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise specified)**

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	P <sub>PK</sub>	500	W
Peak Pulse Current (8/20μs)	I <sub>PP</sub>	24	A
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Operating Temperature Range	T <sub>OP</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise specified)**

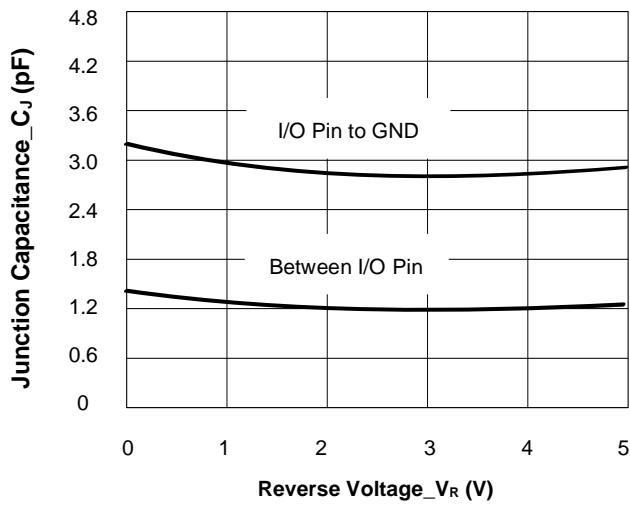
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	V <sub>RWM</sub>			5.0	V	Any I/O pin to ground
Breakdown Voltage	V <sub>BR</sub>	6.0		9.0	V	I <sub>T</sub> = 1mA, any I/O pin to ground
Reverse Leakage Current	I <sub>R</sub>			500	nA	V <sub>RWM</sub> = 5V, any I/O pin to ground
Forward Voltage	V <sub>F</sub>			1.2	V	I <sub>T</sub> =10mA
Clamping Voltage	V <sub>C</sub>		20	24	V	I <sub>PP</sub> = 24A (8/20μs pulse), any I/O pin to ground
Dynamic Resistance <sup>1,2</sup>	R <sub>DYN</sub>		0.25		Ω	T <sub>LP</sub> =0.2/100ns
ESD Clamping Voltage <sup>1</sup>	V <sub>c</sub>		8.7		V	I <sub>PP</sub> = 4A, tp = 0.2/100ns (TLP)
ESD Clamping Voltage <sup>1</sup>	V <sub>c</sub>		11.2		V	I <sub>PP</sub> = 16A, tp = 0.2/100ns (TLP)
Junction Capacitance	C <sub>J</sub>		1.5		pF	V <sub>R</sub> = 0V, f = 1MHz, between I/O pins
Junction Capacitance	C <sub>J</sub>		3.0		pF	V <sub>R</sub> = 0V, f = 1MHz, any I/O pin to ground

Note: 1、TLP Setting: tp=100ns, tr=0.2ns, ITLP and VTLP sample window: t1=70ns to t2=90ns.

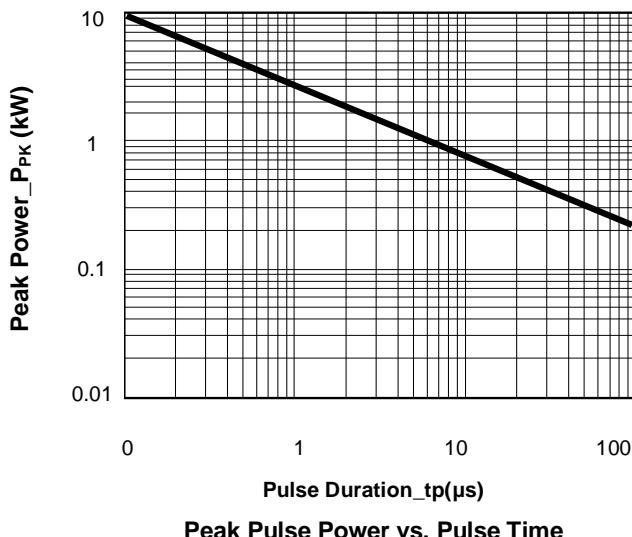
2、Dynamic resistance calculated from IPP=4A to IPP=16A using “Best Fit” .

3、I/O pins are Pin 1, 3, 4 and 6

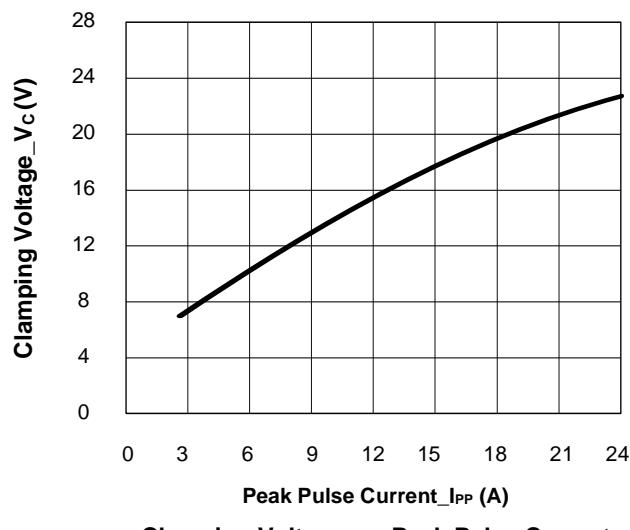
**Typical Performance Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise Specified)**



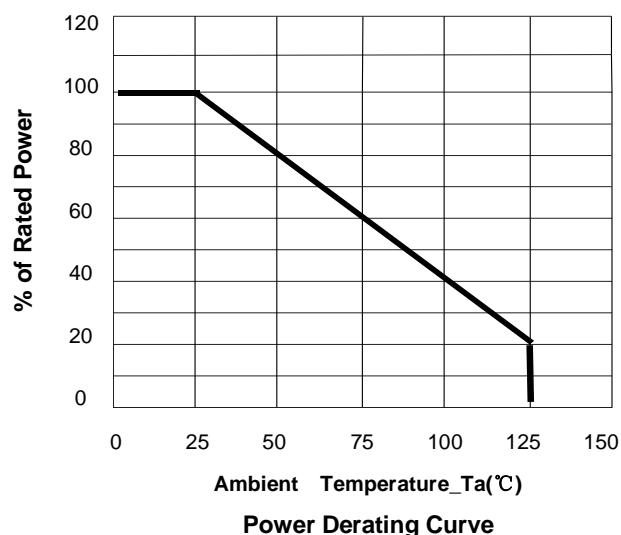
Junction Capacitance vs. Reverse Voltage



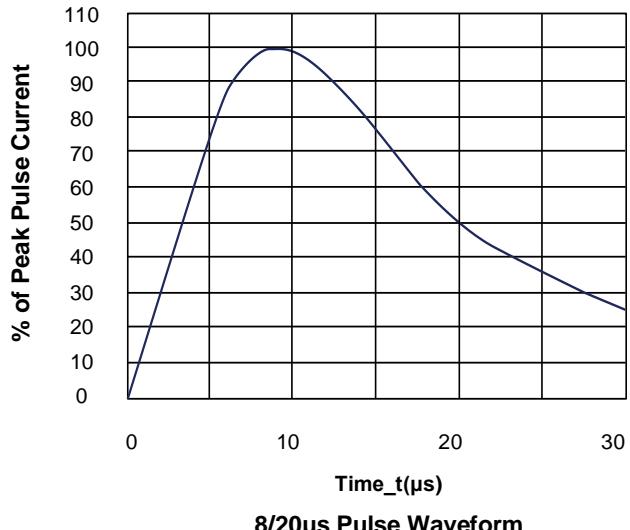
Peak Pulse Power vs. Pulse Time



Clamping Voltage vs. Peak Pulse Current



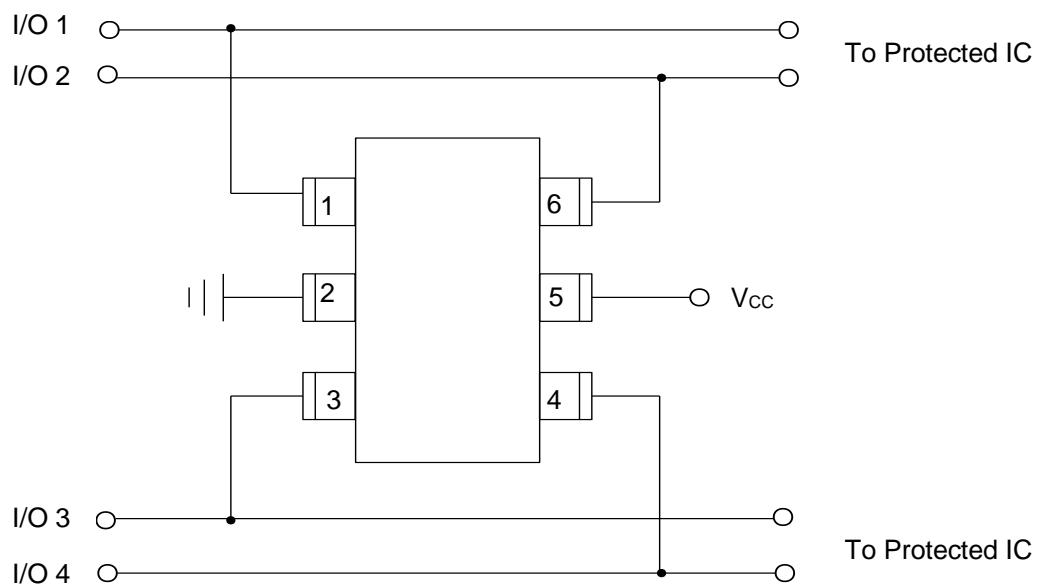
Power Derating Curve



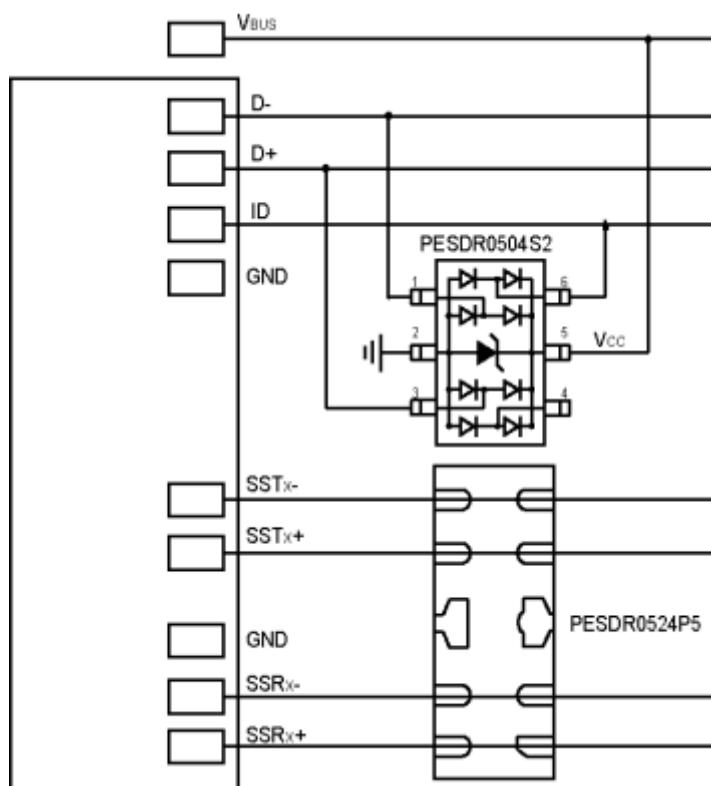
8/20μs Pulse Waveform

## Typical Application

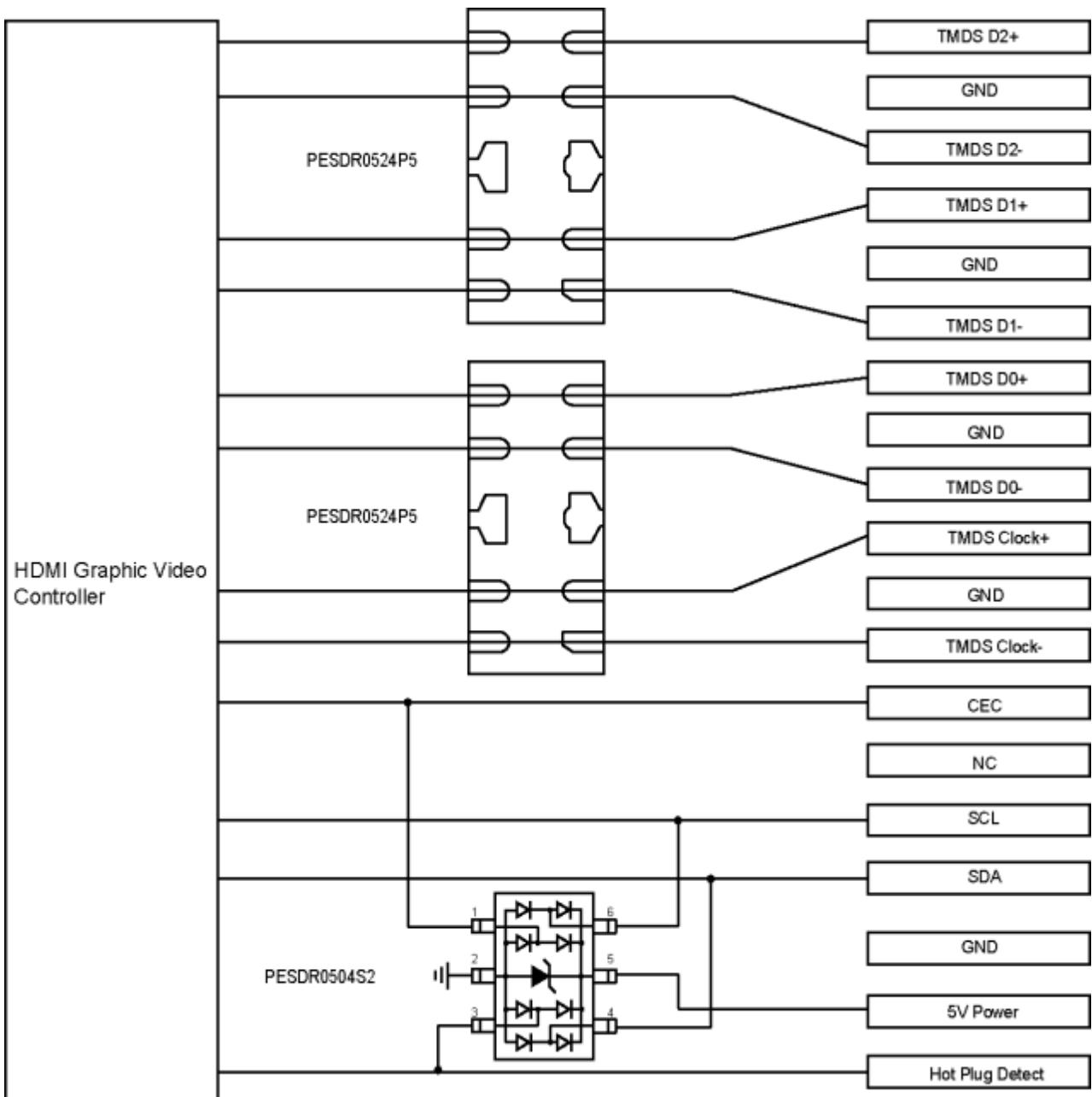
The PESDR0554S2-24A is designed to protect four data lines from transient over-voltages by clamping them to fixed reference. When the voltage on the protected line exceeds the reference voltage (plus diode  $V_F$ ) the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at pins 1, 3, 4 and 6. The negative reference (REF1) is connected at pin 2. This pin should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance. The positive reference (REF2) is connected at pin 5.



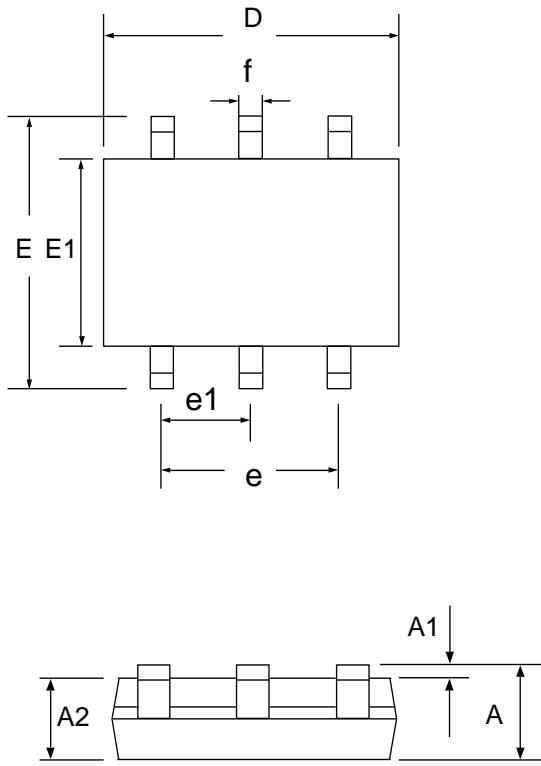
## PESDR0554S2-24A on USB 3.0 Port Application



**PESDR0554S2-24A on HDMI Port Application**

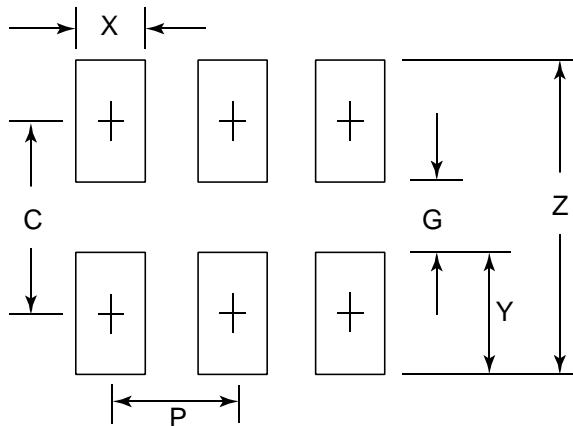


**SOT-23-6 Package Outline Drawing**



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.90		1.45	0.035		0.057
A1	0.00		0.15	0.000		0.006
A2	0.90	1.15	1.30	0.035	0.045	0.051
D	2.80	2.90	3.10	0.110	0.114	0.122
E	2.80 BSC			0.110 BSC		
E1	1.50	1.60	1.75	0.060	0.063	0.069
e	1.90 BSC			0.075 BSC		
e1	0.95 BSC			0.037 BSC		
f	0.30		0.50	0.012		0.020

**Suggested Land Pattern**



SYM	DIMENSIONS	
	MILLIMETERS	
	INCHES	INCHES
C	2.50	0.098
G	1.40	0.055
P	0.95	0.037
X	0.60	0.024
Y	1.10	0.043
Z	3.60	0.141